

• General Description

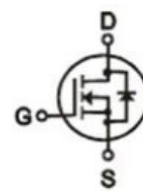
The ZM027N03D combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

• Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

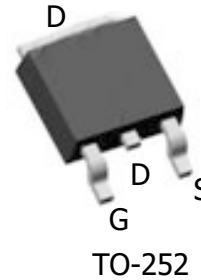
- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

• Product Summary


$V_{DS} = 30V$

$R_{DS(ON)} = 2.7m\Omega$

$I_D = 95A$


• Ordering Information:

Part NO.	ZM027N03D
Marking	ZM027N03
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2500

• Absolute Maximum Ratings ($T_C = 25^\circ C$)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_D @ T_C = 25^\circ C$	95	A
	$I_D @ T_C = 75^\circ C$	72	A
	$I_D @ T_C = 100^\circ C$	60	A
Pulsed Drain Current ^①	I_{DM}	220	A
Total Power Dissipation	$P_D @ T_C = 25^\circ C$	70	W
Total Power Dissipation	$P_D @ T_A = 25^\circ C$	2.8	W
Operating Junction Temperature	T_J	-55 to 175	$^\circ C$
Storage Temperature	T_{STG}	-55 to 175	$^\circ C$
Single Pulse Avalanche Energy	E_{AS}	350	mJ
Avalanche Current	$I_{AS} I_{AR}$	60	A

●Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	1.8	° C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	45	° C/W
Soldering temperature, wave soldering for 10s	T _{sold}	-	-	265	° C

●Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30			V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250uA	1.2		2.5	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1.0	uA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Static Drain-source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =24A		2.7	3.6	mΩ
		V _{GS} =4.5V, I _D =12A		3.6	5.5	mΩ
Forward Transconductance	g _{FS}	V _{DS} =25V, I _D =10A		30		s
Source-drain voltage	V _{SD}	I _S =24A			1.28	V

●Dynamic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C _{iss}	f = 1MHz, V _{DS} =25V	-	2800	-	pF
Output capacitance	C _{oss}		-	420	-	
Reverse transfer capacitance	C _{rss}		-	280	-	
Gate Resistance	R _g	f = 1MHz		2.5		Ω
Total gate charge	Q _g	V _{DD} = 25V I _D = 8A V _{GS} = 4.5V	-	26	-	nC
Gate - Source charge	Q _{gs}		-	4.3	-	
Gate - Drain charge	Q _{gd}		-	6.9	-	
Turn-ON Delay time	t _{D(on)}	V _{GS} =10V,		12		ns
Turn-ON Rise time	t _r	V _{DS} =15V		44		ns
Turn-Off Delay time	t _{D(off)}	R _G =3.3Ω,		50		ns
Turn-Off Fall time	t _f	I _D =15A		15		ns
Reverse Recovery Time	t _{RR}			5.8		ns

Charge Time	t_a	VDD = 20 V, dIS/dt=100A/us, IS = 30 A	3.4	ns
Discharge Time	t_b		2.4	ns
Reverse Recovery Charge	Q_{RR}		1.6	nC

Note: ① Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;

Fig.1 Power Dissipation

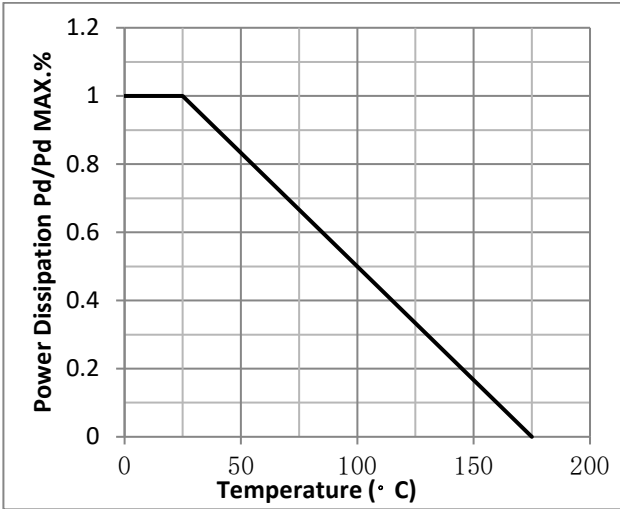


Fig.2 Typical output Characteristics

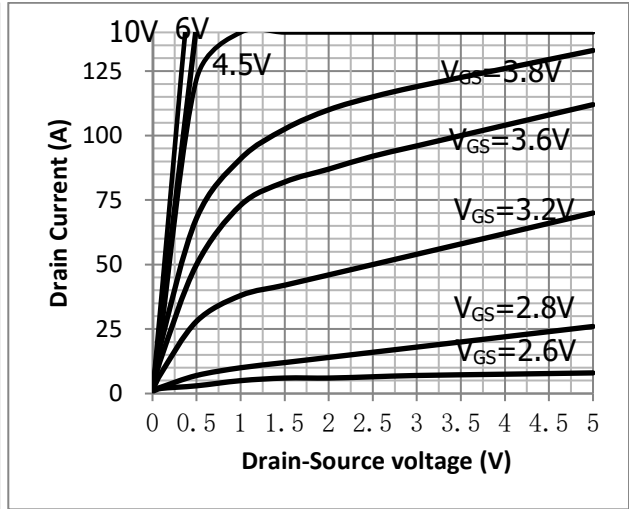


Fig.3 Threshold Voltage V.S Junction Temperature

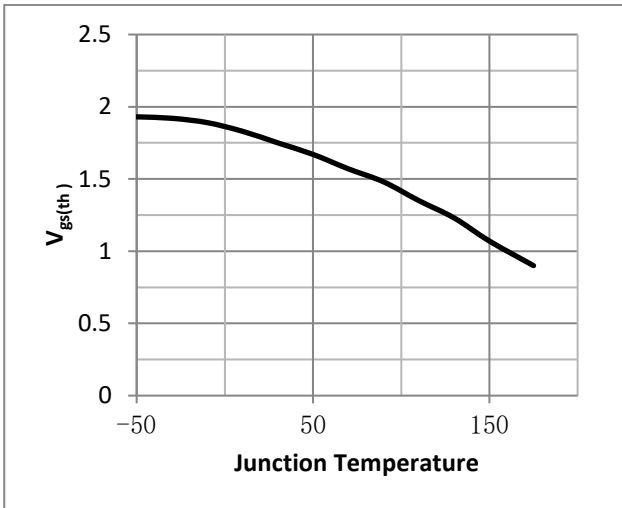


Fig.4 Resistance V.S Drain Current

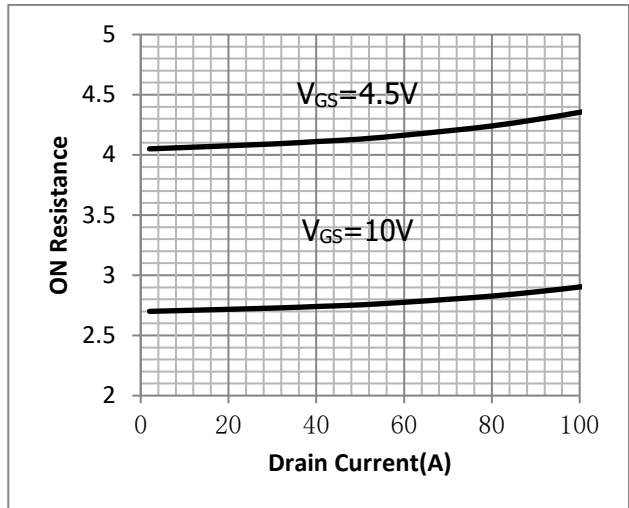


Fig.5 On-Resistance VS Gate Source Voltage

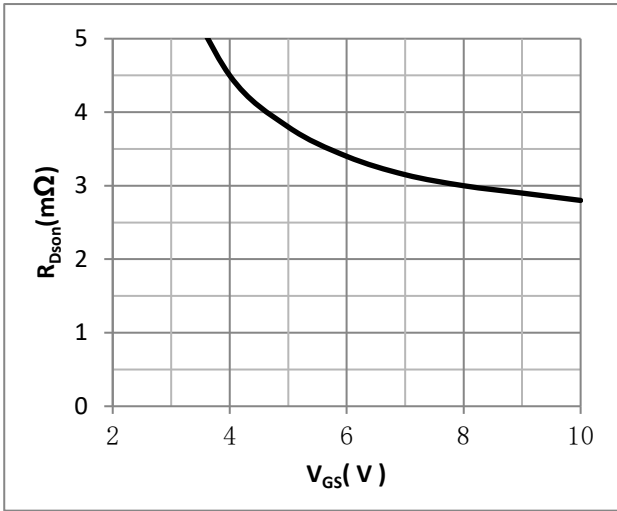


Fig.6 On-Resistance V.S Junction Temperature

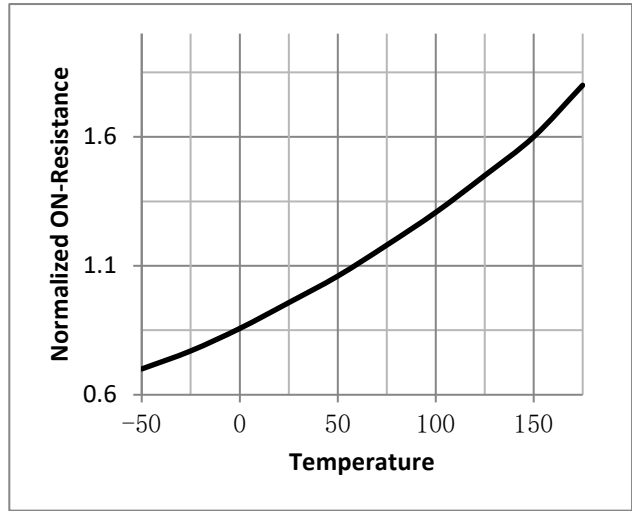


Fig.7 SOA Maximum Safe Operating Area

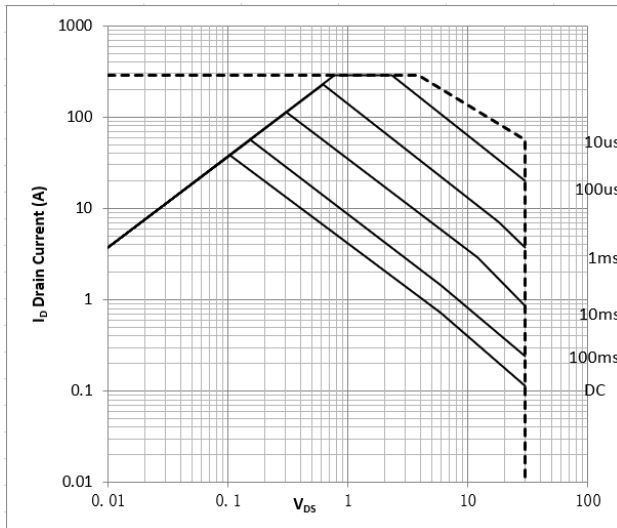


Fig.8 I_D -Junction Temperature

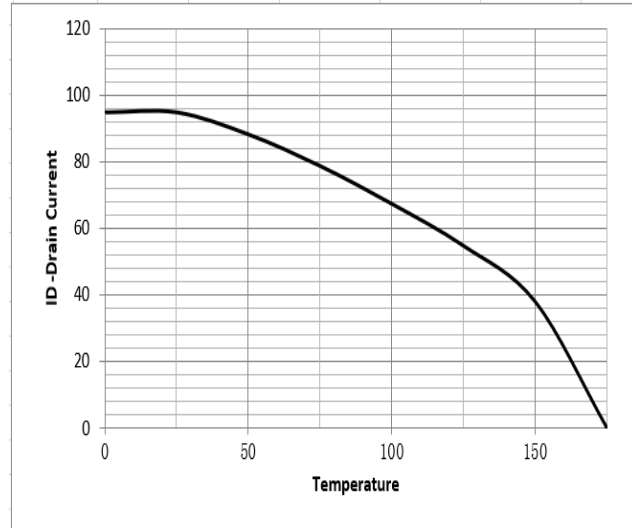


Figure 9. Diode Forward Voltage vs. Current

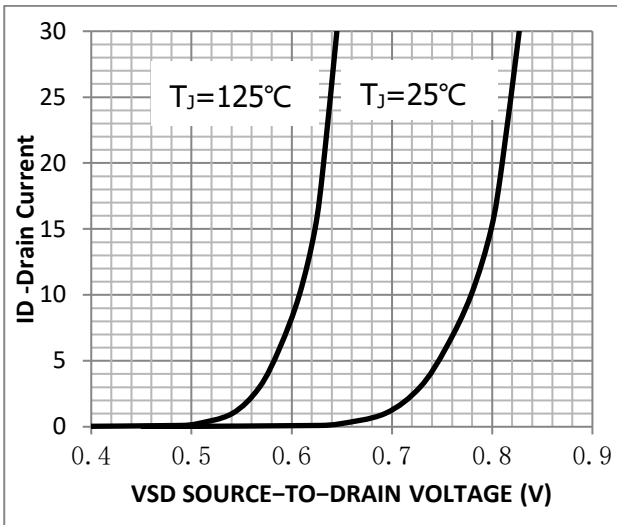


Figure 10. Transfer Characteristics

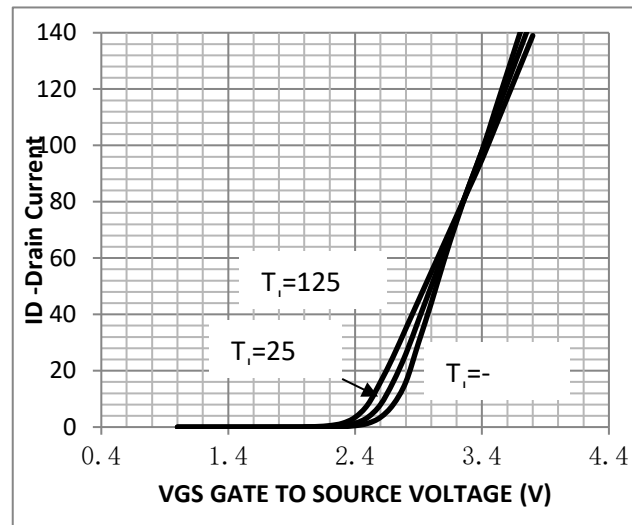


Figure 11. Gate-to-Source and

Fig.12 Capacitance Variation

Drain-to-Source Voltage vs. Total Charge

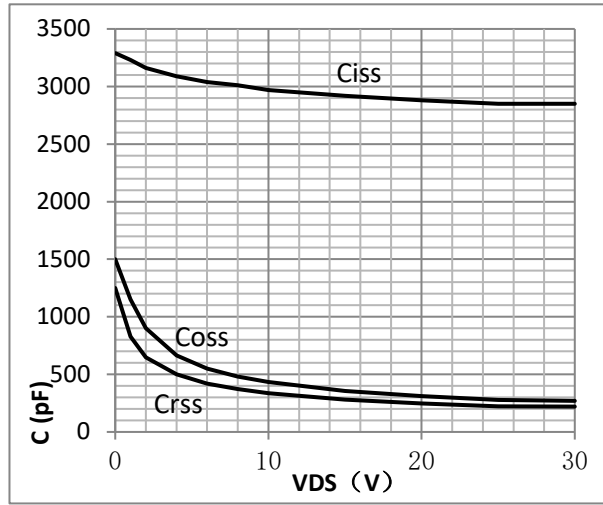
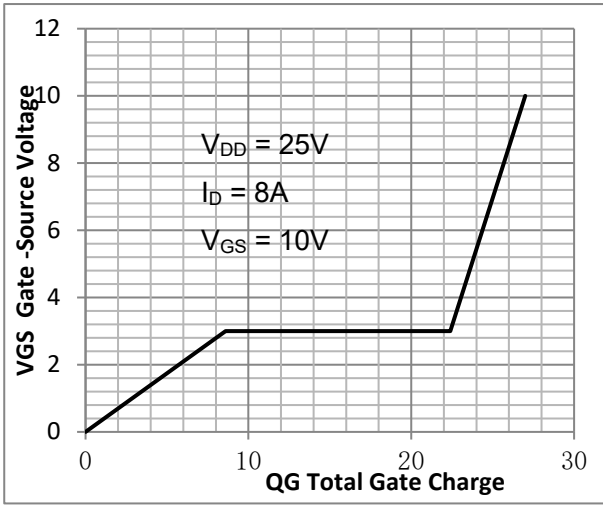


Fig.13 Switching Time Measurement Circuit

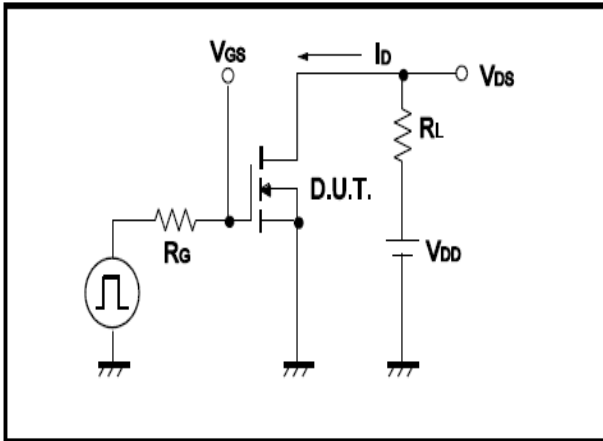


Fig.14 Gate Charge Waveform

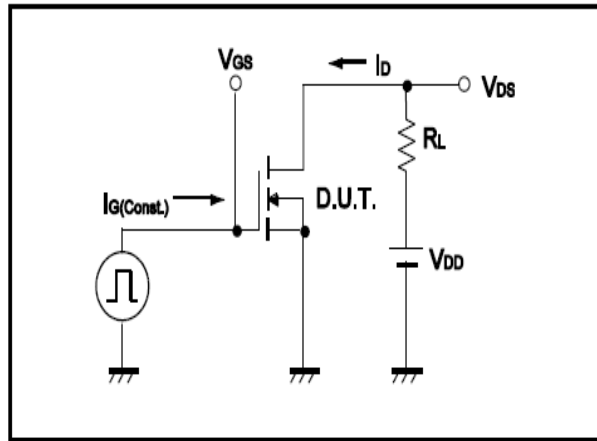


Fig.15 Avalanche Measurement Circuit

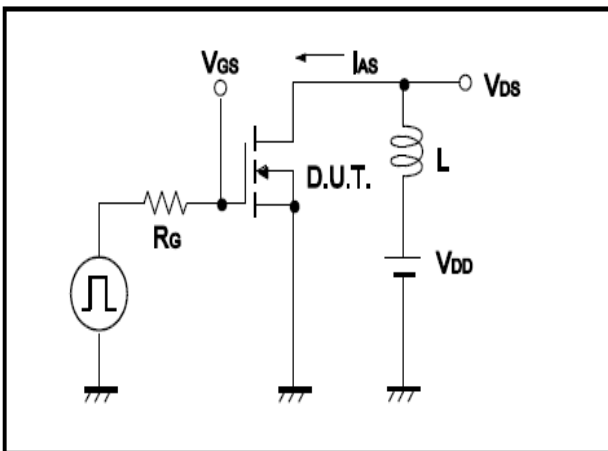


Fig.16 Avalanche Waveform

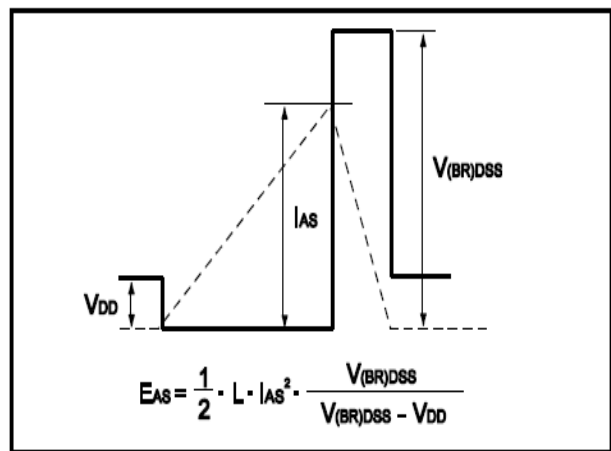
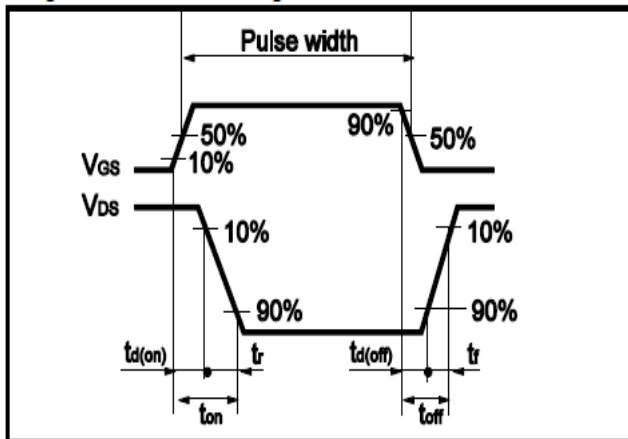


Fig.17 Gate Charge Waveform





•Dimensions (TO-252)

Unit: mm

SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	B	0.85	1.25
b	0.50	0.80	b1	0.50	0.90
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.25	2.35
L1	9.20	10.60	e2	4.45	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			

